Surface Mount

RF Transformer

TRS1-182-75-7+

75Ω 10 to 1800 MHz

Generic photo used for illustration purposes only

CASE STYLE: TT1618-2

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Maximum Ratings

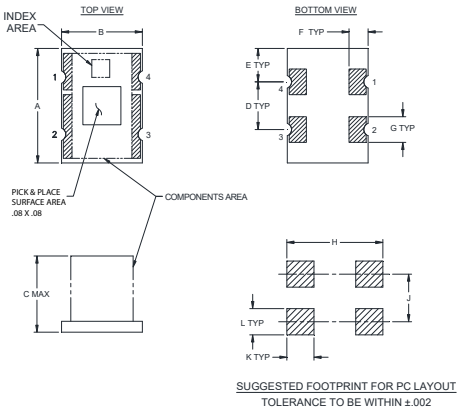
Operating Temperature	-40°C to 100°C
Storage Temperature	-55°C to 125°C
RF Power	1W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

PRIMARY DOT	1
PRIMARY	2
SECONDARY DOT	3
SECONDARY	4

Outline Drawing



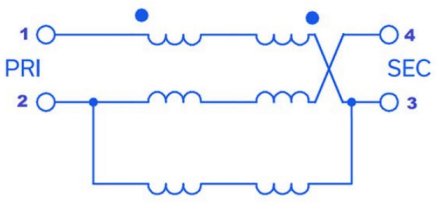
Outline Dimensions (inch / mm)

A	B	C	D	E	F
.240	.170	.160	.100	.070	.040
6.10	4.32	4.06	2.54	1.78	1.02

G	H	J	K	L	wt.
.054	.202	.100	.057	.055	grams
1.37	5.13	2.54	1.45	1.40	2.8

Test board for TRS1-182-75-7+ is TB-875+

Electrical Schematic



Features

- suitable for tin/lead and RoHS solder systems
- wideband, 10 to 1800 MHz
- balanced transmission line
- good return loss, 20 dB typ. at 1 dB band
- excellent amplitude unbalance, 0.3 dB typ.
- aqueous washable
- excellent intermod suppression

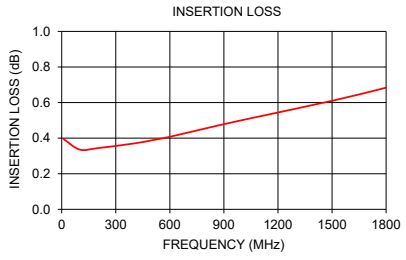
Electrical Specifications at 25°C

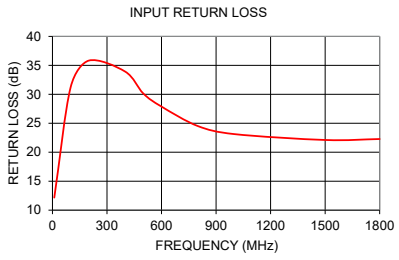
Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio			1		:1
Frequency Range		10		1800	MHz
Insertion Loss[1]	50 - 1200		0.6	1	dB
	10 - 1800		0.9	2	
Amplitude Unbalance	50 -1000		0.3	0.7	dB
	1000 - 1200		0.5	1.1	
	10 - 1800		0.7	1.5	
Phase Unbalance	50 -1000		2	4	Deg.
	1000 - 1200		3	6	
	10 - 1800		7.5	15	
Primary Return Loss	50 - 500	16	22		dB
	500 - 1000	13	20		
	1000 - 1200	12	20		
	10 - 1800	8	12.5		

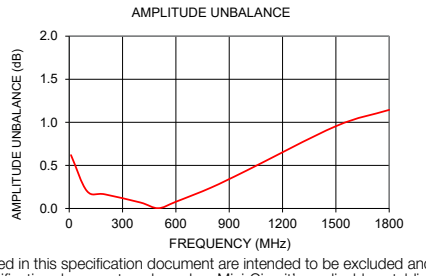
1. Insertion Loss is referenced to mid-band loss, 0.25 dB typ.

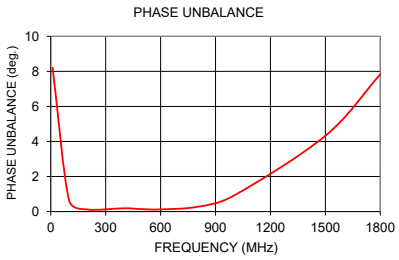
Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
10	0.40	12.17	0.62	8.22
50	0.33	26.38	0.21	1.41
100	0.34	31.22	0.20	0.64
200	0.34	35.82	0.16	0.12
400	0.37	33.92	0.07	0.19
500	0.39	30.13	0.00	0.14
600	0.41	27.88	0.08	0.12
1000	0.50	23.13	0.44	0.91
1200	0.55	22.28	0.66	1.87
1800	0.68	22.28	1.14	7.84









Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

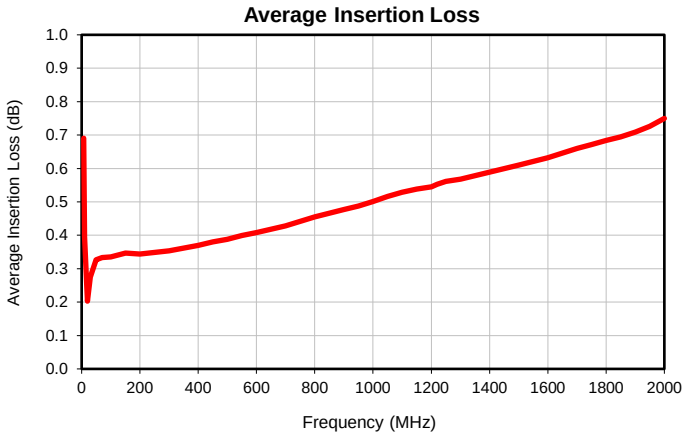
RF Transformer TRS1-182-75-7+

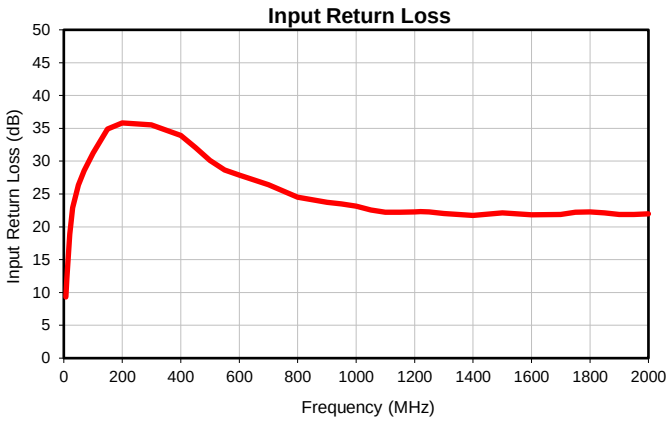
Typical Performance Data

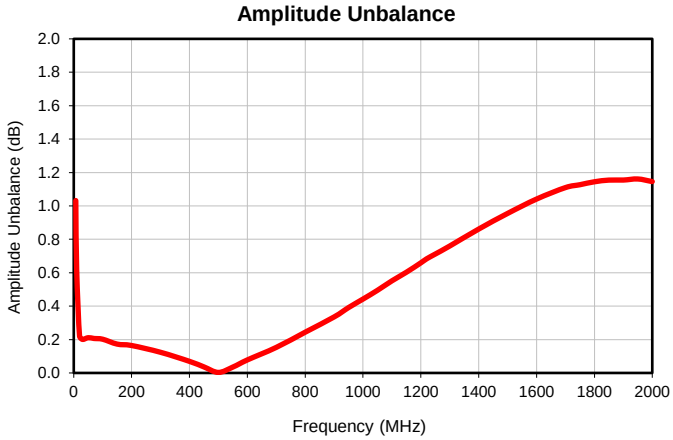
FREQUENCY MHz	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
7	0.69	9.31	1.03	10.09
10	0.40	12.17	0.62	8.22
20	0.20	18.88	0.22	4.20
30	0.27	22.90	0.20	2.50
50	0.33	26.38	0.21	1.41
70	0.33	28.58	0.21	0.99
100	0.34	31.22	0.20	0.64
150	0.35	34.88	0.17	0.39
200	0.34	35.82	0.16	0.12
300	0.35	35.53	0.12	0.07
400	0.37	33.92	0.07	0.19
450	0.38	32.08	0.04	0.17
500	0.39	30.13	0.00	0.14
550	0.40	28.64	0.04	0.12
600	0.41	27.88	0.08	0.12
700	0.43	26.41	0.15	0.03
800	0.46	24.52	0.24	0.27
900	0.48	23.74	0.34	0.58
950	0.49	23.50	0.39	0.71
1000	0.50	23.13	0.44	0.91
1050	0.52	22.56	0.49	1.14
1100	0.53	22.22	0.55	1.36
1150	0.54	22.21	0.60	1.59
1200	0.55	22.28	0.66	1.87
1220	0.55	22.30	0.68	1.99
1250	0.56	22.27	0.71	2.22
1300	0.57	22.03	0.76	2.56
1400	0.59	21.75	0.86	3.34
1500	0.61	22.12	0.96	4.32
1600	0.63	21.85	1.04	5.39
1700	0.66	21.90	1.11	6.57
1750	0.67	22.24	1.13	7.22
1800	0.68	22.28	1.14	7.84
1850	0.69	22.11	1.15	8.59
1900	0.71	21.88	1.15	9.24
1950	0.73	21.86	1.16	9.90
2000	0.75	21.96	1.15	10.61

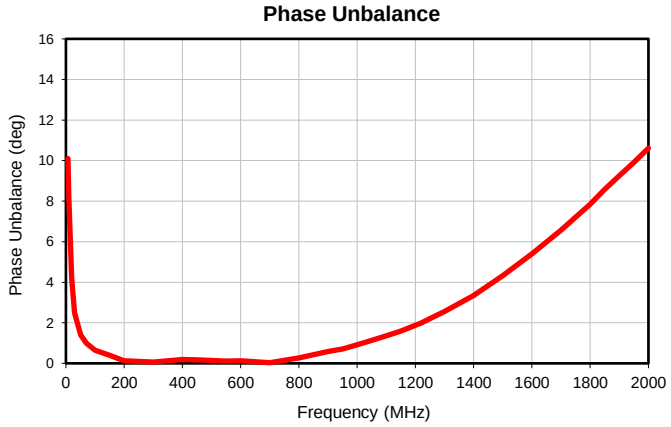
RF Transformer TRS1-182-75-7+

Typical Performance Data





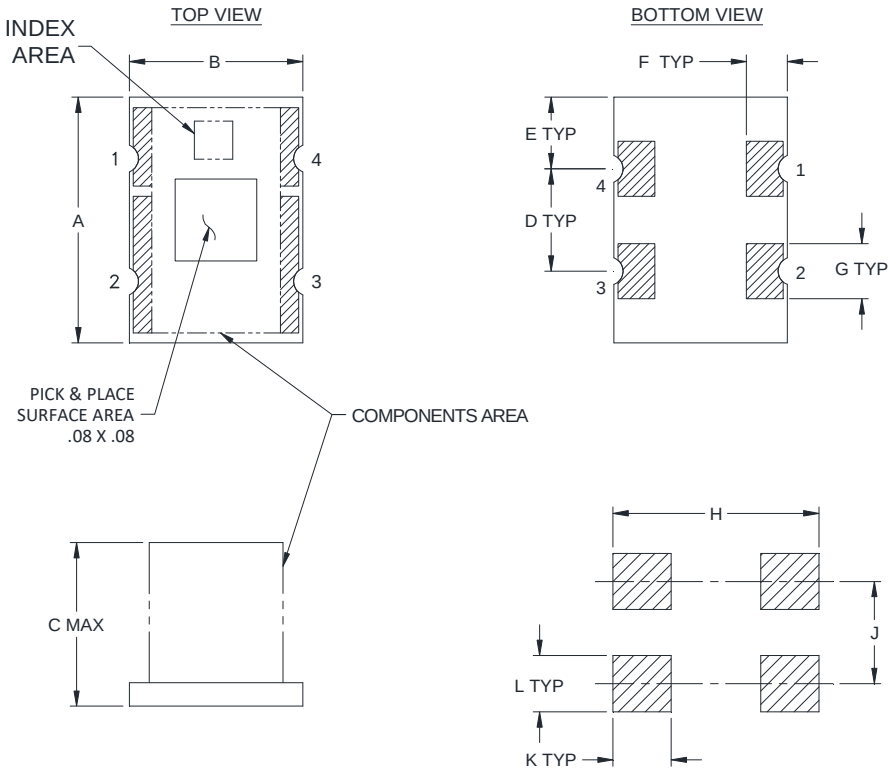




Case Style TT

Outline Dimensions

TT1618-2



SUGGESTED FOOTPRINT FOR PC LAYOUT
TOLERANCE TO BE WITHIN ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT GRAMS
TT1618-2	.240 (6.10)	.170 (4.32)	.160 (4.06)	.100 (2.54)	.070 (1.78)	.040 (1.02)	.054 (1.37)	.202 (5.13)	.100 (2.54)	.057 (1.45)	.055 (1.40)	2.80

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, Base material: Printed wiring laminate.
2. Termination finish: 3-5 µ inch (.08-.13 microns) Gold over 120-240 µ inch (3.05-6.10 microns) Nickel plate. All models, (+) suffix.
3. Orientation Dot on Unit corresponds to Pin #1.

Mini-Circuits

Environmental Specifications ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215